G3VM-101BR/ER

MOS FET Relays

Compact, General-purpose, Analog-switching MOS FET Relays, with 2-A Switching.

- Continuous load current of 2 A. (Connection C : 4 A)
- Switches minute analog signals.
- Dielectric strength of 2,500 Vrms between I/O.

RoHS compliant

Application Examples

- Communication equipment
- Test & Measurement equipment
- Security equipment
- Factory Automation equipment
- Power circuit

■List of Models

Note:	The actual product is marked	differently from the
	image shown here.	

NEW

Terminal Arrangement/Internal Connections



Note: The actual product is marked differently from the image shown here.

Package type	Contact form	Terminals	Load voltage (peak value) *	Model	Minimum package quantity	
гаскауе туре	Contact Ionni		Load vollage (peak value) ~	Model	Number per stick	Number per tape and reel
	1a	PCB terminals		G3VM-101BR	50	
DIP6		Surface-mounting terminals	100 V	0 V G3VM-101ER		
				G3VM-101ER (TR)		1,500

* The AC peak and DC value are given for the load voltage.

■ Absolute Maximum Ratings (Ta = 25°C)

	Item		Symbol	Rating	Unit	Measurement conditions	Note:
	LED forward current		lF	30	mA		
Input	Repetitive peak LED forward current		IFP	1	Α	100 µs pulses, 100 pps	
	LED forward current reduction rate		∆IF/°C	-0.3	mA/°C	Ta ≥ 25°C	
	LED reverse voltage		VR	5	V		
	Connection temperature		TJ	125	°C		
	Load voltage (AC peak/DC)		Voff	100	V		
	Continuous load current	Connection A	lo	2	A	Connection A: AC peak/DC Connection B and C: DC	
Output		Connection B		2			
		Connection C		4		Connection B and C. BO	
	ON current reduction rate	Connection A	∆lo/°C	-20	mA/°C	Ta≥25°C	
		Connection B		-20			
		Connection C		-40			
	Pulse ON current		lop	6	Α	t = 100 ms, Duty = 1/10	
	Connection temperature		ТJ	125	°C		
Dielectric strength between I/O (See note 1.)		Vi-o	2500	Vrms	AC for 1 min		
Operating temperature		Та	-40 to +85	°C	With no icing or condensation		
Sto	Storage temperature		Tstg	-55 to +125	°C	With no icing or condensation	
So	Soldering temperature			260	°C	10 s	

1. The dielectric strength between the input and output was checked by applying voltage between all pins as a group on the LED side and all pins as a group on the light-receiving side.

Connection Diagram

Connection A	$\begin{bmatrix} 1 & 6 \\ - & Load \\ 2 & 5 \\ 0 & r \\ DC \\ 0 \\ 0 \end{bmatrix}$
Connection B	$\begin{bmatrix} 1 & 6 \\ 2 & 5 \\ 3 & 4 \end{bmatrix} \xrightarrow{\text{DC}} \xrightarrow{\text{DC}}$
Connection C	$\begin{bmatrix} 1 & 6 \\ 2 & 5 \\ 3 & 4 \end{bmatrix} \rightarrow DC =$

■ Electrical Characteristics (Ta = 25°C)

	Item		Symbol	Minimum	Typical	Maximum	Unit	Measurement conditions		
LED forward voltage		VF	1.18	1.33	1.48	V	I⊧ = 10 mA			
E Reverse current		IR			10	μA	VR = 5 V			
Input	Capacity between t	erminals	Ст		70		pF	V = 0, f = 1 MHz	Note:	2. Turn
Ī	Trigger LED forwar	d current	IFT		0.5	3	mA	lo = 1 A		
	Maximum	Connection A			100	200	mΩ	IF = 5 mA, lo = 2 A, t < 1s		
0	resistance with	Connection B	Ron		50		mΩ	IF = 5 mA, lo = 2 A, t < 1s		
Output	output ON	Connection C			25		mΩ	IF = 5 mA, lo = 4 A, t < 1s		
Ħ	Current leakage when the r	elay is open	ILEAK			1.0	μA	Voff = 100 V		
	Capacity between t	erminals	COFF		1000		pF	V = 0, f = 1 MHz		
Cap	acity between I/O t	erminals	CI-O		0.8		pF	f = 1 MHz, Vs = 0 V		
Insulation resistance between I/O terminals		Ri-o	1000			MΩ	VI-0 = 500 VDC, $RoH \le 60\%$			
Turn-ON time		ton		2	5	ms	I⊧ = 5 mA, R∟ = 200 Ω,		`	
Turn-OFF time		toff		0.1	1	ms	V _{DD} = 20 V (See note 2.)			



Recommended Operating Conditions

Use the G3VM under the following conditions so that the Relay will operate properly.

Item	Symbol	Minimum	Typical	Maximum	Unit
Load voltage (AC peak/DC)	Vdd			80	v
Operating LED forward current	lF	5	10	25	mA
Continuous load current (AC peak/DC)	lo			2	А
Operating temperature	Та	-20		65	°C

■Engineering Data

LED forward current vs. Ambient temperature



Continuous load current vs. On-state voltage



Turn ON, Turn OFF time vs. LED forward current



Continuous load current vs. Ambient temperature



On-state resistance vs.

Ambient temperature



Turn ON, Turn OFF time vs. Ambient temperature



LED forward current vs. LED forward voltage



Trigger LED forward current vs. Ambient temperature



Current leakage vs. Ambient temperature



■Safety Precautions

• Refer to "Common Precautions" for all G3VM models.

DIP G3VM-101BR/ER

■ Appearance

DIP (Dual Inline Package)



Note: The actual product is marked differently from the image shown here.

Dimensions

(Unit: mm)



Application examples provided in this document are for reference only. In actual applications, confirm equipment functions and safety before using the product.
Consult your OMRON representative before using the product under conditions which are not described in the manual or applying the product to nuclear control systems, railroad systems, aviation systems, vehicles, combustion systems, medical equipment, amusement machines, safety equipment, and other systems or equipment that may have a serious influence on lives and property if used improperly. Make sure that the ratings and performance characteristics of the product provide a margin of safety for the system or equipment, and be sure to provide the system or equipment with double safety mechanisms.

Note: Do not use this document to operate the Unit.

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Cat. No. K142-E1-02 0412(0412)(O)

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